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| APPLICATION NO.                                    | FILING DATE   | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO.     | CONFIRMATION NO. |
|--|---------------|----------------------|-------------------------|------------------|
| 10/039,333   | 11/09/2001    | Gene H. Lee          | 5545 (2616-012)         | 1508             |
| 32588 75   | 90 02/27/2004 |                      | EXAMINER TRAN, BINH X   |                  |
| 32000  | TERIALS, INC. |                      |                         |                  |
| 2881 SCOTT BLVD. M/S 2061<br>SANTA CLARA, CA 95050 |               |                      | ART UNIT                | PAPER NUMBER     |
| SANTA CLAR   | I, CA 93030   |                      | 1765                    |                  |
|  |               |                      | DATE MAILED: 02/27/2004 |                  |

Please find below and/or attached an Office communication concerning this application or proceeding.

|  | Application No.  | Applicant(s)   |  |  |  |  |
|--|--|--|--|--|--|--|
| Office Action Comments   | 10/039,333   | LEE ET AL.   |  |  |  |  |
| Office Action Summary  | Examiner   | Art Unit   |  |  |  |  |
|  | Binh X Tran  | 1765   |  |  |  |  |
| The MAILING DATE of this communication appears on the cover sheet with the correspondence address<br>Period for Reply  |  |  |  |  |  |  |
| A SHORTENED STATUTORY PERIOD FOR REPI THE MAILING DATE OF THIS COMMUNICATION  - Extensions of time may be available under the provisions of 37 CFR 1 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a re - If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statu - Any reply received by the Office later than three months after the maili earned patent term adjustment. See 37 CFR 1.704(b).  Status   | 136(a). In no event, however, may a reply be timply within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from te, cause the application to become ABANDONE.  | nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).                                   |  |  |  |  |
| 1)⊠ Responsive to communication(s) filed on <u>07 November 2003</u> .  |  |  |  |  |  |  |
| 2a) ☐ This action is <b>FINAL</b> . 2b) ☑ This   | s action is non-final.   |  |  |  |  |  |
| 3) Since this application is in condition for allowance except for formal matters, prosecution as to the ments is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.  |  |  |  |  |  |  |
| Disposition of Claims  |  |  |  |  |  |  |
| 4) ☐ Claim(s) 1-21 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration.  5) ☐ Claim(s) is/are allowed.  6) ☐ Claim(s) 1-21 is/are rejected.  7) ☐ Claim(s) is/are objected to.  8) ☐ Claim(s) are subject to restriction and/or election requirement.   |  |  |  |  |  |  |
| Application Papers   |  |  |  |  |  |  |
| 9) The specification is objected to by the Examiner.  10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).  11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.  |  |  |  |  |  |  |
| Priority under 35 U.S.C. §§ 119 and 120  |  |  |  |  |  |  |
| 12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:  1. Certified copies of the priority document 2. Certified copies of the priority documents. Copies of the certified copies of the priority documents. See the attached detailed Office action for a list 13) Acknowledgment is made of a claim for domest since a specific reference was included in the foreign language points. Acknowledgment is made of a claim for domest since a specific reference was included in the foreign language points. Acknowledgment is made of a claim for domest reference was included in the first sentence of the specific reference was included in the first sentence of the specific reference was included in the first sentence of the specific reference was included in the first sentence of the specific reference was included in the first sentence of the specific reference was included in the first sentence of the specific reference was included in the first sentence of the specific reference was included in the first sentence of the specific reference was included in the first sentence of the specific reference was included in the first sentence of the specific reference was included in the first sentence of the specific reference was included in the first sentence of the specific reference was included in the specific reference | nts have been received. Into have been received in Applicationity documents have been received au (PCT Rule 17.2(a)). Into of the certified copies not received at the certified copies not received at the certified copies not received at the specification of the specification at the specification of the specification at the | on No ed in this National Stage ed. e) (to a provisional application) in an Application Data Sheet. eived. and/or 121 since a specific |  |  |  |  |
| Attachment(s)  |  |  |  |  |  |  |
| <ol> <li>Notice of References Cited (PTO-892)</li> <li>Notice of Draftsperson's Patent Drawing Review (PTO-948)</li> <li>Information Disclosure Statement(s) (PTO-1449) Paper No(s)</li> </ol>   | 5) Notice of Informal F  | (PTO-413) Paper No(s) vatent Application (PTO-152)   |  |  |  |  |

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### **DETAILED ACTION**

### Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-4, 7-8 are rejected under 35 U.S.C. 102(b) as being anticipated by Kumar et al. (EP 0837497 A2).

Kumar discloses a plasma etching a tungsten-containing layer (16, i.e. tungsten silicide) having a patterned hard mask (18) comprising:

placing the substrate in a plasma zone;

introducing into a plasma zone a process gas mix comprising  $NF_3$  and  $Cl_2$  (col. 4 lines 23-28);

forming a plasma from the process gas mix to etch the tungsten-containing layer substantially anisotropically (Fig 1-2, col. 3).

Kumar does not explicitly state that the etch rate of tungsten-containing layer is greater than the etch rate of the hard mask. However, Kumar discloses that the etch rate of tungsten-containing layer and polysilicon is about the same (i.e. selectivity 1:1, col. 3 lines 8-10). Kumar also discloses that the polysilicon is etched at a greater rate than hard mask (selectivity 5:1, col. 3 lines 11-14). Base on this information, the

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examiner interprets that Kumar implicitly discloses the etch rate of tungsten-containing layer is greater (more specific 5 times faster) than the etch rate the hard mask.

Respect to claims 2-3, the examiner interprets that Kumar discloses the tungsten containing layer is etched at an etch rate about 5 times faster than the hard mask (read on the limitation "at an etch rate at least twice ..." and/or "2.5 greater than..."). Respect to claim 4, Kumar discloses that variation in etch uniformity of 3% or less, etch rate microloading was less than 3% (read on "critical dimension loss of less than 4%") and sidewalls angle close to 90 ° (col. 3 lines 13-17, col. 5 lines 10-15). Respect to claim 7, Kumar discloses the gas mix consist essentially of NF<sub>3</sub> and Cl<sub>2</sub> (col. 7 lines 20-25). Respect to claim 8, Kumar discloses the process gas mix further comprise a passivator gas (col. 2 line 39-43).

## Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to

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consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

5. Claims 5-6, 9-18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kumar in view of Qian et al. (US 6,136,211).

Claims 5-6 differ from Kumar by the specific volumetric flow ratio of NF<sub>3</sub>:Cl<sub>2</sub>. In an etching method, Qian teaches the volumetric flow ratio of NF<sub>3</sub>:Cl<sub>2</sub> is a result effective variable (col. 4 lines 20-29). The result effective variable is commonly determined by routine experiment. The process of conducting routine experiments so as to produce an expected result is obvious to one of ordinary skill in the art. Hence, it would have been obvious to one having ordinary skill in the art, at the time of invention, modify Kumar in view of Qian by performing routine experiments to obtain optimal flow ratio.

Respect to claim 9, Kumar fails to disclose that the hard mask layer comprises silicon nitride. However, Kumar discloses the hard mask layer is made of silicon oxide. Qian teaches that the hard mask layer can be either silicon oxide or silicon nitride (col. lines 12-14, col. 8 lines 24-26). It would have been obvious to one having ordinary skill in the art, at the time of invention, to modify Kumar in view of Qian by using silicon nitride hard mask because equivalent and substitution of one for the other would produce an expected result.

Respect to claim 10, Kumar discloses the step of applying the energy to the coils and the electrode to ionize the process gas (Fig 3A). However, Kumar fails to explicitly disclose applying the RF energy to the inductor coil. Qian discloses the step of applying RF energy (110, 155) to the inductor coil (115) and process electrodes. It would have

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been obvious to one having ordinary skill in the art, at the time of invention, to modify Kumar and Qian by applying RF energy to inductor coil and process electrodes because it will directly increase plasma density over the substrate. The limitations of claims 11-18 have been discussed above.

5. Claims 19-21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kumar and Qian, and further in view of Davis (US 5,164,330).

Respect to claim 19, Kumar and Qian fail to disclose an over etch process mix comprising Ar and Cl<sub>2</sub>. However, Kumar clearly disclose the over etch process using a gas mixture comprises Cl<sub>2</sub> (col. 4 lines 44-62). In a plasma etching, Davis discloses an over etch process using Ar and Cl<sub>2</sub> (col. 6-7). It would have been obvious to one having ordinary skill in the art, at the time of invention to modify Kumar and Qian by performing an over etch process using Ar and Cl<sub>2</sub> because it will effective remove the tungsten. Further, equivalent and substitution of one for the other would produce an expected result.

The limitations of claims 20-21 have been discussed above.

### Response to Arguments

6. Applicant's arguments with respect to claims 1-21 have been considered but are most in view of the new ground(s) of rejection.

#### Conclusion

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Binh X Tran whose telephone number is (571) 272-

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1469. The examiner can normally be reached on Monday-Thursday and every other Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine G Norton can be reached on (571) 272-1465. The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0661.

Binh X. Tran

NADINE G. NORTON SUPERVISORY PATENT EXAMINER